

2A, 200V-1000V High Efficient Surface Mount Rectifiers

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling application
- Switching mode converters and inverters, computer and telecommunication.

MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.028 g (approximately)

| KEY PARAMETERS | | |
|----------------|------------|------|
| PARAMETER | VALUE | UNIT |
| $I_{F(AV)}$ | 2 | A |
| V_{RRM} | 200 - 1000 | V |
| I_{FSM} | 60 | A |
| $T_{J\ MAX}$ | 150 | °C |
| Package | SOD-128 | |
| Configuration | Single Die | |



SOD-128

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | | | | | |
|--|-----------------------------------|-------------|--------|--------|--------|--------|------|
| PARAMETER | SYMBOL | HS2DFS | HS2GFS | HS2JFS | HS2KFS | HS2MFS | UNIT |
| Marking code on the device | | HS2DFS | HS2GFS | HS2JFS | HS2KFS | HS2MFS | |
| Repetitive peak reverse voltage | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms value | $V_{R(RMS)}$ | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | $I_{F(AV)}$ | 2 | | | | | A |
| Surge peak forward current, single half sine-wave superimposed on rated load per diode | 8.3ms at $T_A = 25^\circ\text{C}$ | I_{FSM} | 60 | | | | A |
| | 1.0ms at $T_A = 25^\circ\text{C}$ | | 120 | | | | A |
| Junction temperature | T_J | -55 to +150 | | | | | °C |
| Storage temperature | T_{STG} | -55 to +150 | | | | | °C |

| THERMAL PERFORMANCE | | | |
|--|-----------------|-----|---------------|
| PARAMETER | SYMBOL | TYP | UNIT |
| Junction-to-lead thermal resistance | $R_{\theta JL}$ | 17 | $^{\circ}C/W$ |
| Junction-to-ambient thermal resistance | $R_{\theta JA}$ | 53 | $^{\circ}C/W$ |
| Junction-to-case thermal resistance | $R_{\theta JC}$ | 21 | $^{\circ}C/W$ |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted) | | | | | | |
|---|------------------|--|----------|------|------|---------|
| PARAMETER | | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
| Forward voltage per diode ⁽¹⁾ | HS2DFS | $I_F = 1.0A, T_J = 25^{\circ}C$ | V_F | 0.81 | - | V |
| | | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 0.87 | 1.00 | V |
| | | $I_F = 1.0A, T_J = 125^{\circ}C$ | | 0.67 | - | V |
| | | $I_F = 2.0A, T_J = 125^{\circ}C$ | | 0.74 | 0.82 | V |
| | HS2GFS | $I_F = 1.0A, T_J = 25^{\circ}C$ | | 0.90 | - | V |
| | | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 0.99 | 1.30 | V |
| | | $I_F = 1.0A, T_J = 125^{\circ}C$ | | 0.76 | - | V |
| | | $I_F = 2.0A, T_J = 125^{\circ}C$ | | 0.86 | 0.96 | V |
| | HS2JFS | $I_F = 1.0A, T_J = 25^{\circ}C$ | | 1.00 | - | V |
| | | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 1.10 | 1.70 | V |
| | | $I_F = 1.0A, T_J = 125^{\circ}C$ | | 0.80 | - | V |
| | | $I_F = 2.0A, T_J = 125^{\circ}C$ | | 0.92 | 1.10 | V |
| | HS2KFS HS2MFS | $I_F = 1.0A, T_J = 25^{\circ}C$ | | 1.30 | - | V |
| | | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 1.48 | 1.70 | V |
| | | $I_F = 1.0A, T_J = 125^{\circ}C$ | | 0.94 | - | V |
| | | $I_F = 2.0A, T_J = 125^{\circ}C$ | | 1.11 | 1.23 | V |
| Reverse current @ rated V_R per diode ⁽²⁾ | | $T_J = 25^{\circ}C$ | I_R | - | 1 | μA |
| | | $T_J = 125^{\circ}C$ | | - | 80 | μA |
| Reverse recovery time | | $I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$ | t_{rr} | - | 50 | ns |
| | | | | - | 75 | ns |
| Junction capacitance per diode | | 1 MHz, $V_R = 4.0V$ | C_J | 32 | - | pF |
| | | | | 25 | - | pF |
| | | | | 17 | - | pF |
| | | | | 12 | - | pF |

Notes:

(1) Pulse test with PW=0.3 ms

(2) Pulse test with PW=30 ms

| ORDERING INFORMATION | | |
|------------------------------------|----------------|-------------------|
| ORDERING CODE⁽¹⁾ | PACKAGE | PACKING |
| HS2xFS M3G | SOD-128 | 3,500 / 7" reel |
| HS2xFS M2G | SOD-128 | 14,000 / 13" reel |

Notes:

(1) "x" defines voltage from 200V(HS2DFS) to 1000V(HS2MFS)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

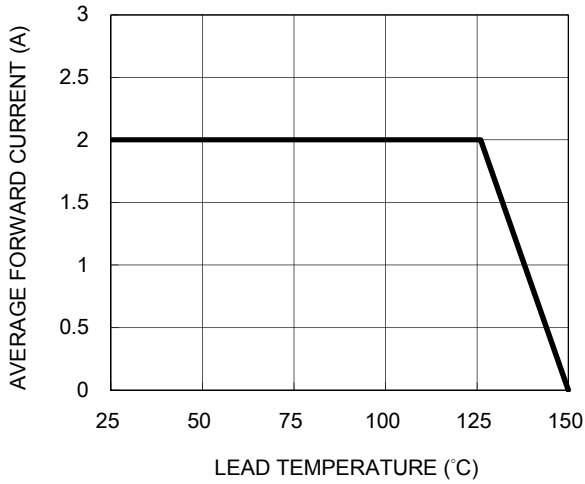


Fig.2 Typical Junction Capacitance

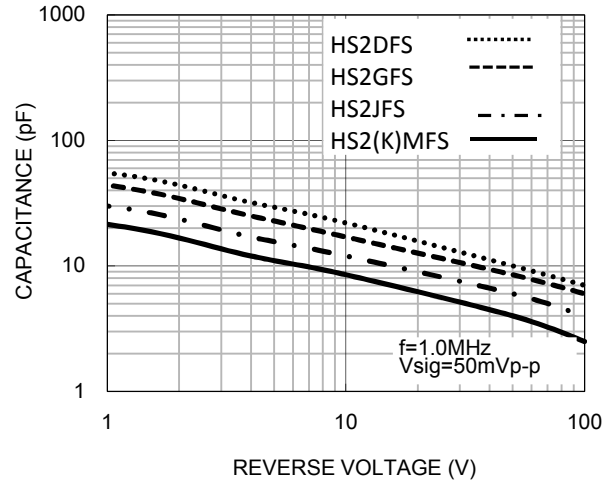


Fig.3 Typical Reverse Characteristics

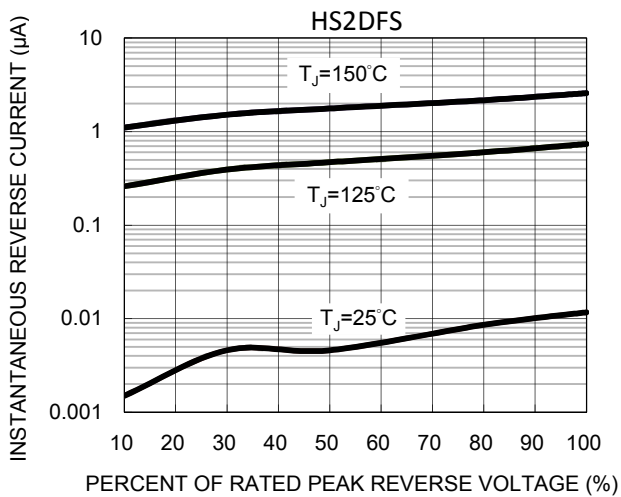


Fig.4 Typical Forward Characteristics

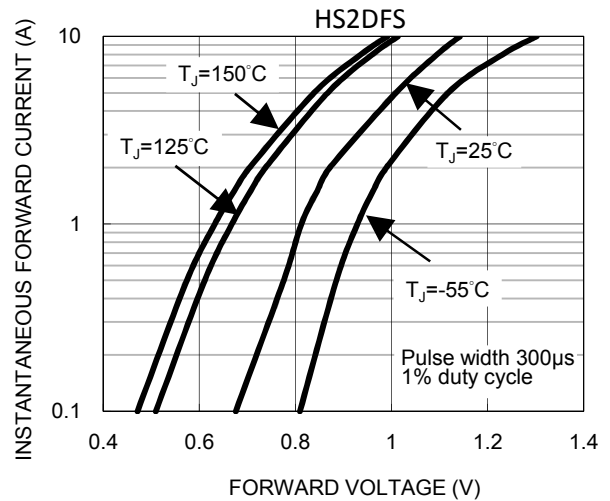


Fig.5 Typical Reverse Characteristics

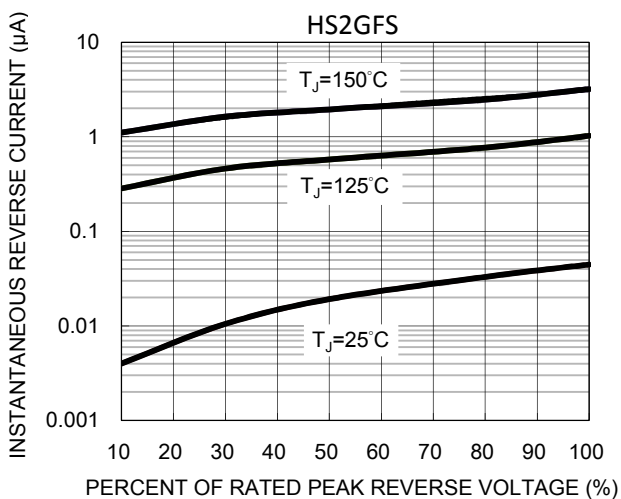


Fig.6 Typical Forward Characteristics

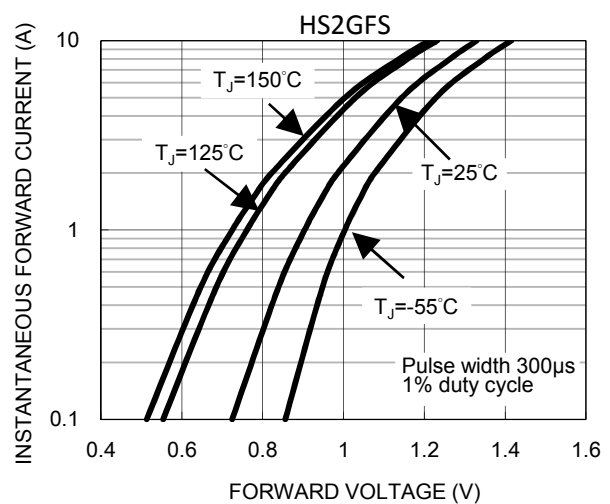


Fig.7 Typical Reverse Characteristics

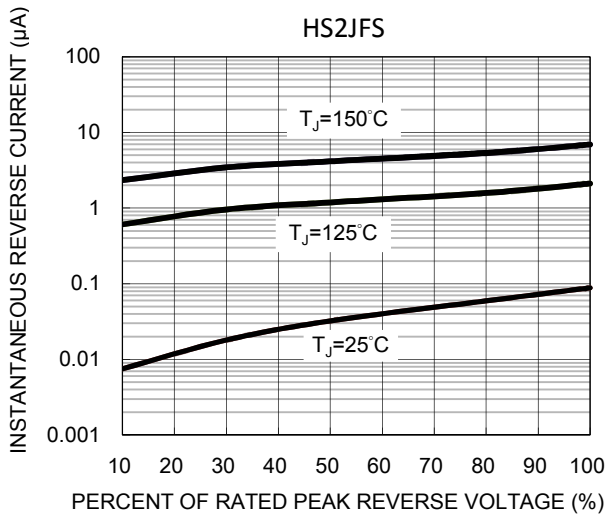


Fig.8 Typical Forward Characteristics

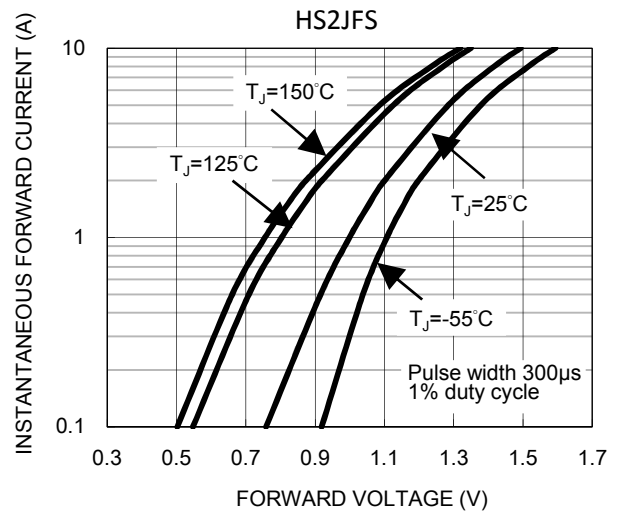


Fig.9 Typical Reverse Characteristics

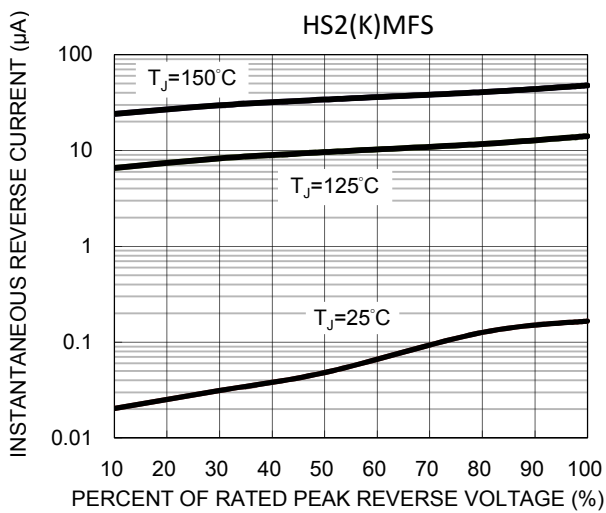


Fig.10 Typical Forward Characteristics

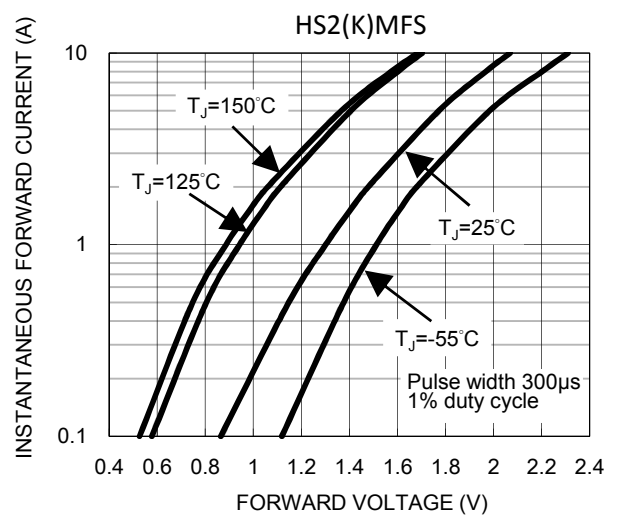
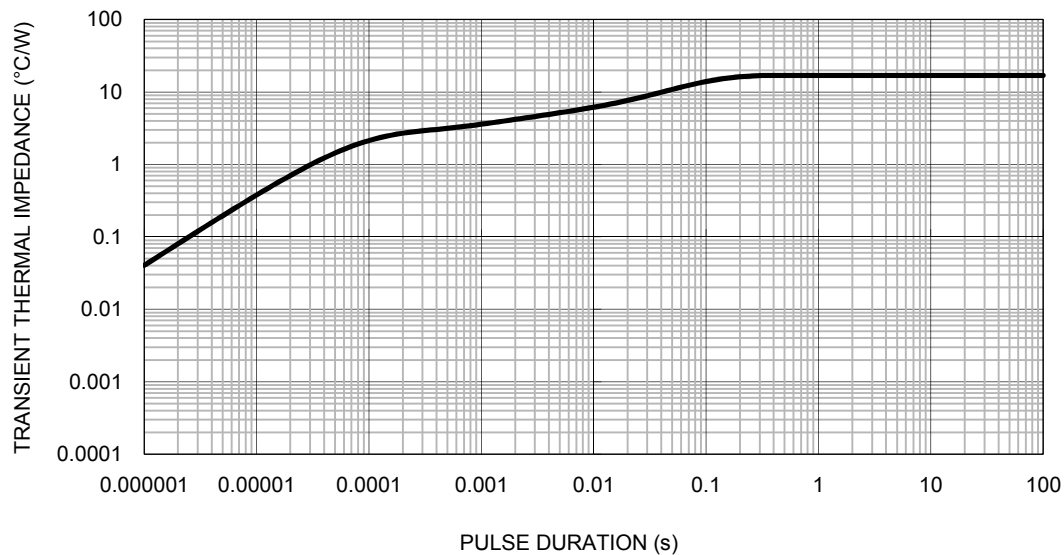
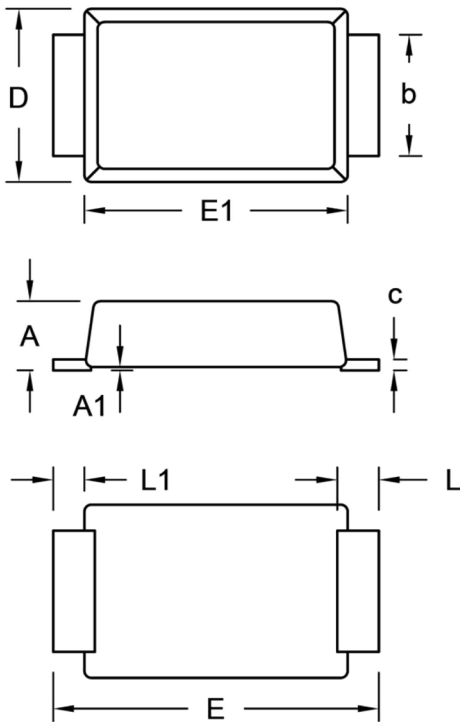


Fig.11 Typical Transient Thermal Impedance



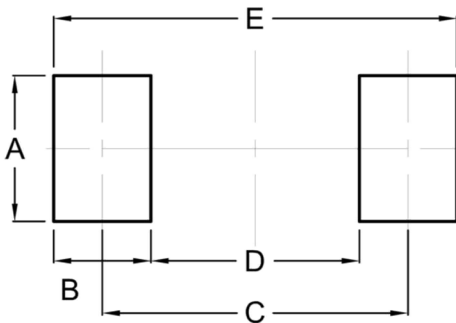
PACKAGE OUTLINE DIMENSIONS

SOD-128



| DIM. | Unit (mm) | | Unit (inch) | |
|------|-----------|------|-------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.90 | 1.10 | 0.035 | 0.043 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 1.60 | 1.90 | 0.063 | 0.075 |
| c | 0.10 | 0.22 | 0.004 | 0.009 |
| D | 2.30 | 2.70 | 0.091 | 0.106 |
| E | 4.40 | 5.00 | 0.173 | 0.197 |
| E1 | 3.60 | 4.00 | 0.142 | 0.157 |
| L | 0.40 | 0.80 | 0.016 | 0.031 |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A | 2.10 | 0.083 |
| B | 1.40 | 0.055 |
| C | 4.40 | 0.173 |
| D | 3.00 | 0.118 |
| E | 5.80 | 0.228 |

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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